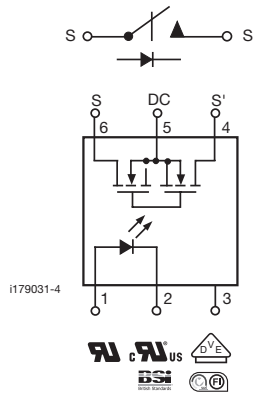
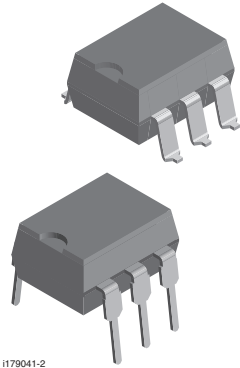


1 Form A Solid State Relay



FEATURES

- Isolation test voltage 5300 V_{RMS}
- Current limit protection built in
- High reliability monolithic output die
- Low power consumption
- Clean bounce free switching
- High surge capability
- Surface mountable
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS
COMPLIANT

APPLICATIONS

- General telecom switching
- Instrumentation
- Industrial controls

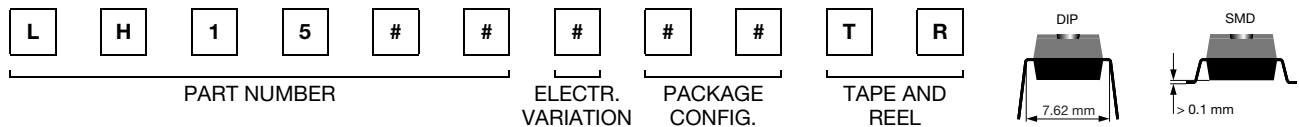
AGENCY APPROVALS

- UL1577: file no. E52744 system code H, double protection
 CSA: certification no. 093751
 BSI: certification no. 7979/7980
 DIN EN: 60747-5-5 (VDE 0884)
 FIMKO: 25419

DESCRIPTION

The LH1510 is an SPST normally open switch (1 form A) that can replace electromechanical relays in many applications. The relay is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry, and MOSFET switches. In addition, the relay employs current-limiting circuitry enabling it to pass FCC 68.302 and other regulatory voltage surge requirements when overvoltage protection is provided. The LH1510 is the only relay in the family that provides current limiting for unidirectional DC applications.

ORDERING INFORMATION



PACKAGE	UL, cUL, BSI, FIMKO, VDE
SMD-6, tubes	LH1510AAB
SMD-6, tape and reel	LH1510AABTR
DIP-6, tubes	LH1510AT

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
SSR				
LED continuous forward current		I _F	50	mA
LED reverse voltage	I _R ≤ 10 μA	V _R	8	V
DC or peak AC load voltage	I _L ≤ 50 μA	V _L	200	V
Continuous DC load current - bidirectional operation		I _L	200	mA
Continuous DC load current - unidirectional operation		I _L	350	mA
Peak load current (single shot)	t = 100 ms	I _P	(1)	

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
SSR				
Ambient temperature range		T_{amb}	- 40 to + 85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 40 to + 150	$^{\circ}\text{C}$
Pin soldering temperature ⁽²⁾	$t = 10\text{ s max.}$	T_{sld}	260	$^{\circ}\text{C}$
Input to output isolation voltage		V_{ISO}	5300	V_{RMS}
Output power dissipation (continuous)		P_{diss}	550	mW

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Refer to current limit performance application note 58 for a discussion on relay operation during transient currents.
- (2) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
LED forward current, switch turn-on	$I_L = 100\text{ mA}$, $t = 10\text{ ms}$	I_{Fon}		0.95	2	mA
LED forward current, switch turn-off	$V_L = \pm 150\text{ V}$	I_{Foff}	0.2	0.85		mA
LED forward voltage	$I_F = 10\text{ mA}$	V_F	1.15	1.27	1.45	V
OUTPUT						
ON-resistance AC/DC: pin 4 (\pm) to 6 (\pm)	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	R_{ON}	6	11.27	15	Ω
ON-resistance DC: pin 4, 6 (+) to 5 (\pm)	$I_F = 5\text{ mA}$, $I_L = 100\text{ mA}$	R_{ON}	1.5	3.15	3.75	Ω
Off-resistance	$I_F = 0\text{ mA}$, $V_L = \pm 100\text{ V}$	R_{OFF}	0.5	80		$G\Omega$
Current limit AC/DC: pin 4 (\pm) to 6 (\pm)	$I_F = 5\text{ mA}$, $V_L = \pm 5\text{ V}$, $t = 5\text{ ms}$	I_{LMT}	300	368	450	mA
Current limit DC: pin 4, 6 (+) to 5 (\pm)	$I_F = 5\text{ mA}$, $V_L = \pm 4\text{ V}$, $t = 5\text{ ms}$	I_{LMT}	600	736	920	mA
Off-state leakage current	$I_F = 0\text{ mA}$, $V_L = \pm 100\text{ V}$	I_O		2.36	200	nA
	$I_F = 0\text{ mA}$, $V_L = \pm 200\text{ V}$	I_O		79.2	1	μA
Output capacitance pin 4 to 6	$I_F = 0\text{ mA}$, $V_L = 1\text{ V}$	C_O		27.75		pF
	$I_F = 0\text{ mA}$, $V_L = 50\text{ V}$	C_O		10.82		pF
Switch offset	$I_F = 5\text{ mA}$	V_{OS}		0.17		μV
TRANSFER						
Capacitance (input to output)	$V_{ISO} = 1\text{ V}$	C_{IO}		0.72		pF
Turn-on time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{on}		0.5	2	ms
Turn-off time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{off}		0.7	2	ms

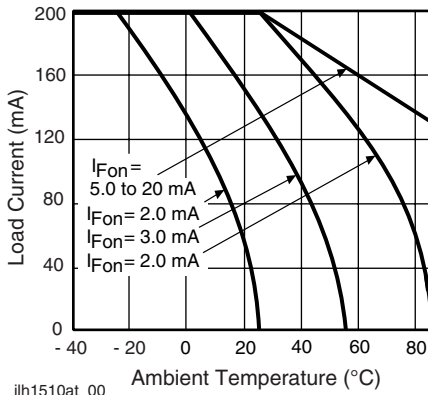
Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.



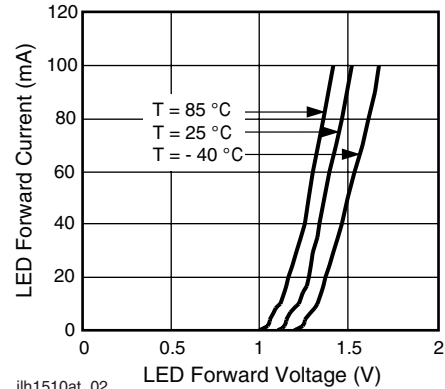
SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	IEC 68 part 1		40/85/21	
Pollution degree	DIN VDE 0109		2	
Tracking resistance (comparative tracking index)	Insulation group IIIa	CTI	175	
Highest allowable overvoltage	Transient overvoltage	V_{IOTM}	8000	V_{peak}
Max. working insulation voltage	Recurring peak voltage	V_{IORM}	890	V_{peak}
Insulation resistance at 25 °C	$V_{IO} = 500 V$	R_{IS}	$\geq 10^{12}$	Ω
Insulation resistance at T_S		R_{IS}	$\geq 10^9$	Ω
Insulation resistance at 100 °C		R_{IS}	$\geq 10^{11}$	Ω
Partial discharge test voltage	Methode a, $V_{pd} = V_{IORM} \times 1.875$	V_{pd}	1669	V_{peak}
Safety limiting values - maximum values allowed in the event of a failure	Case temperature	T_{SI}	175	°C
	Input current	I_{SI}	300	mA
	Output power	P_{SO}	700	mW
Minimum external air gap (clearance)	Measured from input terminals to output terminals, shortest distance through air		≥ 7	mm
Minimum external tracking (creepage)	Measured from input terminals to output terminals, shortest distance path along body		≥ 7	mm

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ °C}$, unless otherwise specified)



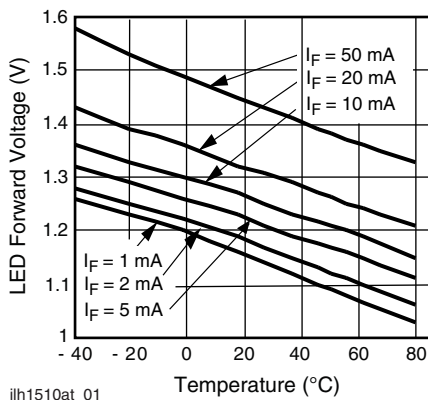
ih1510at_00

Fig. 1 - Recommended Operating Conditions



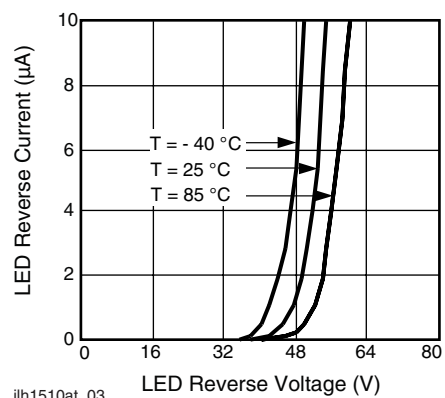
ih1510at_02

Fig. 3 - LED Forward Current vs. LED Forward Voltage



ih1510at_01

Fig. 2 - LED Voltage vs. Temperature



ih1510at_03

Fig. 4 - LED Reverse Current vs. LED Reverse Voltage

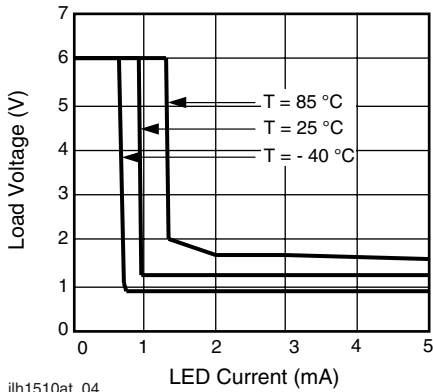


Fig. 5 - LED Current vs. Load Voltage

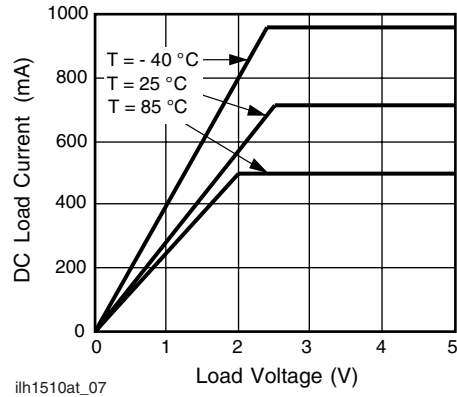


Fig. 8 - DC Load Current vs. Load Voltage

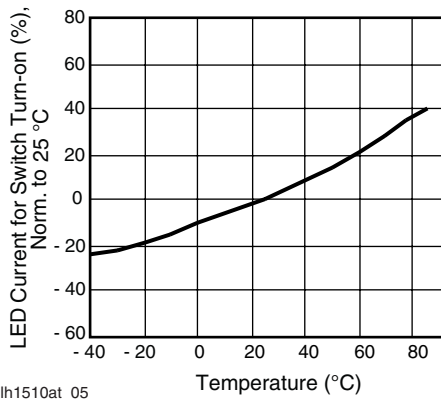


Fig. 6 - LED Current for Switch Turn-on vs. Temperature

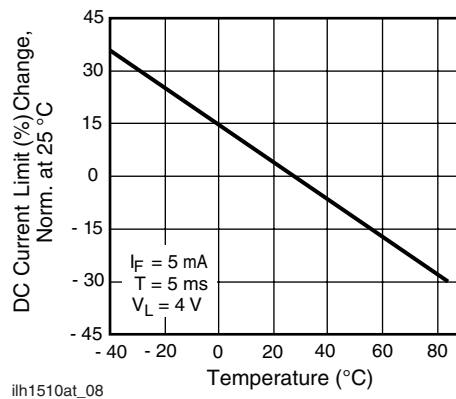


Fig. 9 - DC Current Limit vs. Temperature

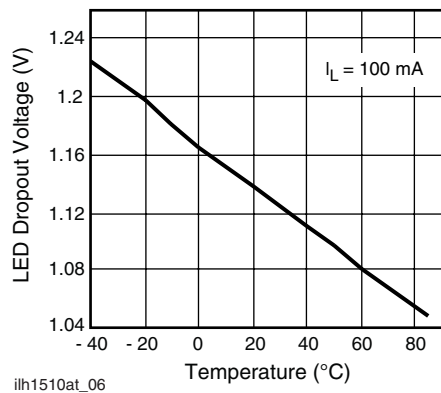


Fig. 7 - LED Dropout Voltage vs. Temperature

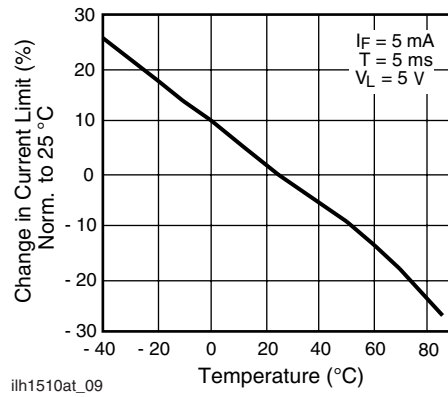
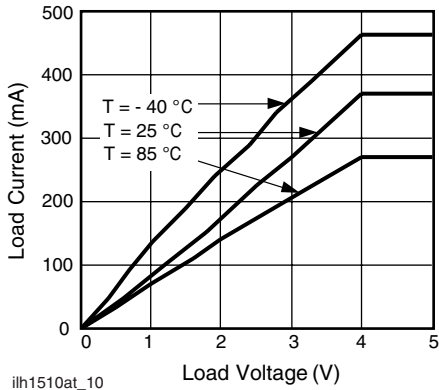
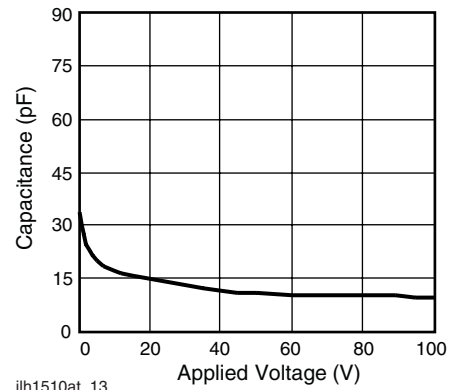


Fig. 10 - Current Limit vs. Temperature



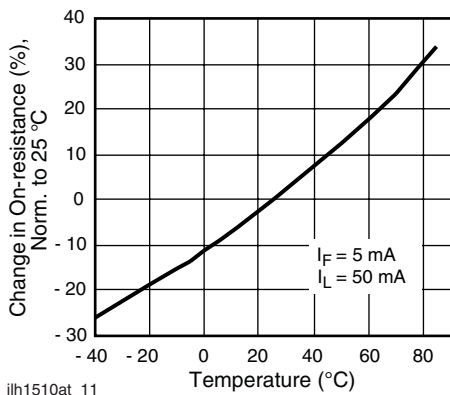
ilh1510at_10

Fig. 11 - Load Current vs. Load Voltage



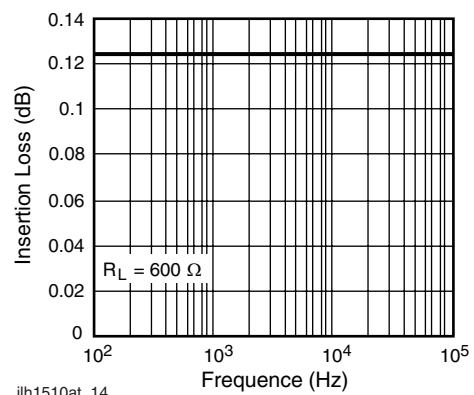
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Fig. 14 - Switch Terminal Capacitance vs. Applied Voltage



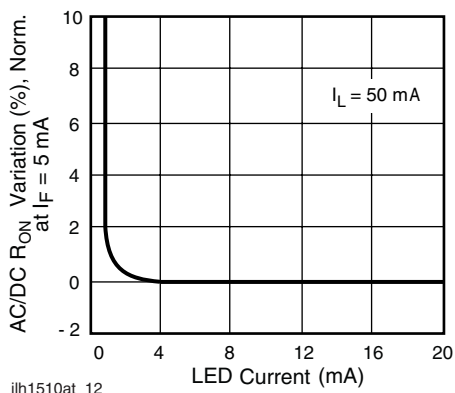
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Fig. 12 - On-Resistance vs. Temperature



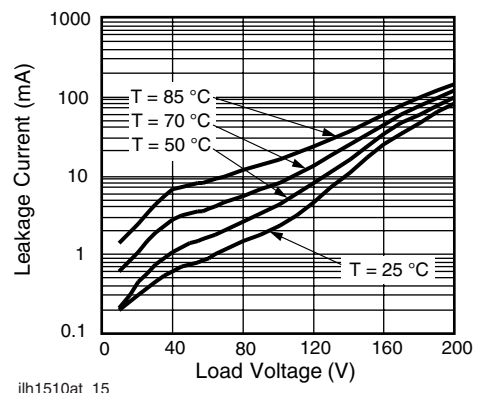
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Fig. 15 - Insertion Loss vs. Frequency



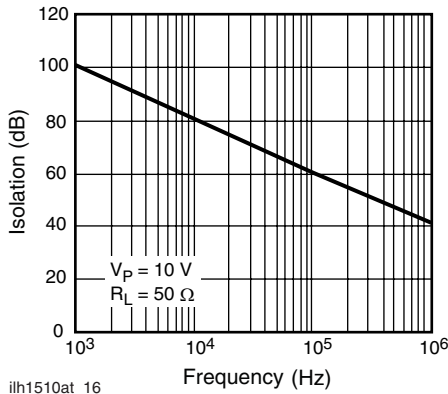
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Fig. 13 - Variation in On-Resistance vs. LED Current



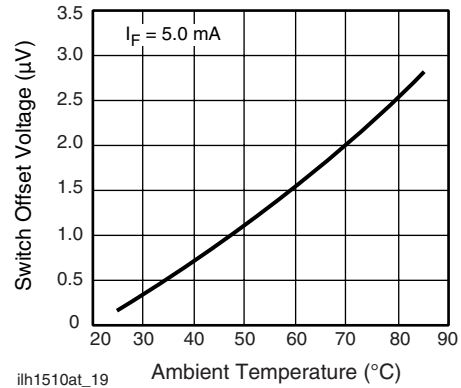
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Fig. 16 - Leakage Current vs. Applied Voltage



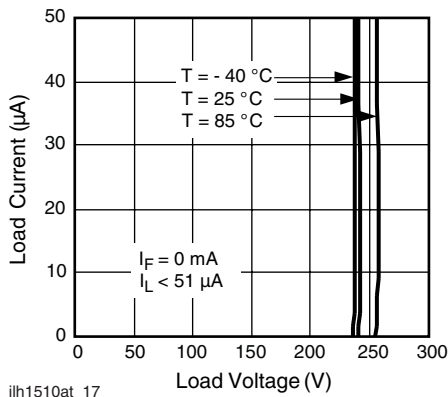
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Fig. 17 - Output Isolation



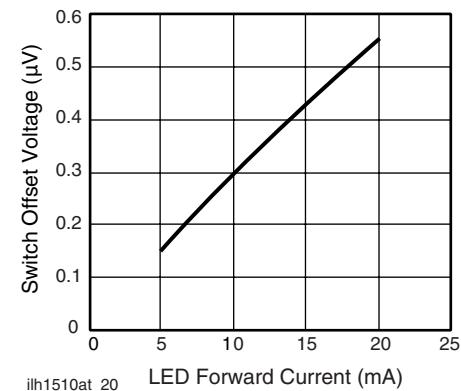
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Fig. 20 - Switch Offset Voltage vs. Temperature



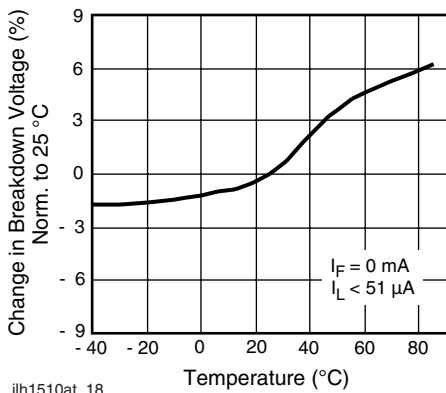
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Fig. 18 - Switch Breakdown Voltage vs. Load Current



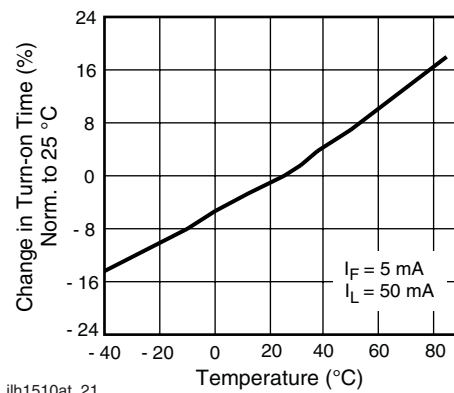
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Fig. 21 - Switch Offset Voltage vs. LED Current



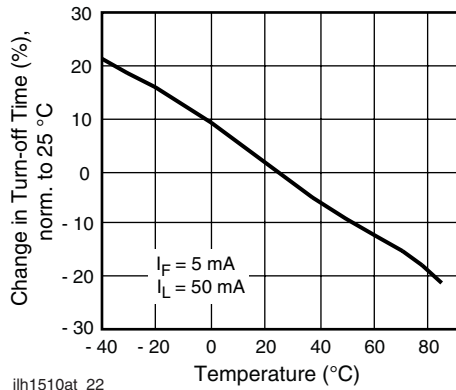
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Fig. 19 - Switch Breakdown Voltage vs. Temperature



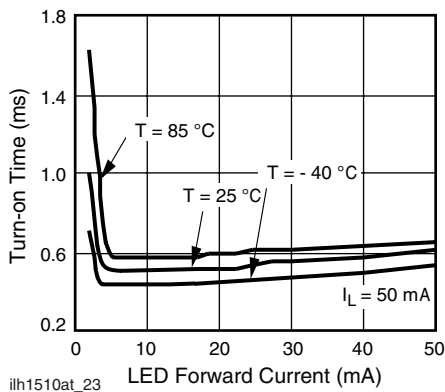
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Fig. 22 - Turn-on Time vs. Temperature



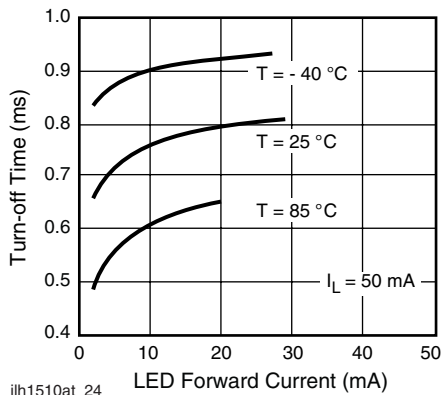
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Fig. 23 - Turn-off Time vs. Temperature



ilh1510at_23

Fig. 24 - Turn-on Time vs. LED Current



ilh1510at_24

Fig. 25 - Turn-off Time vs. LED Current

LH1510AAB, LH1510AABTR, LH1510AT

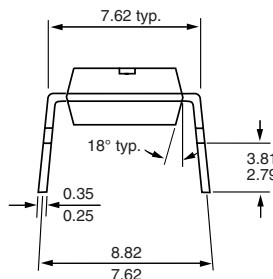
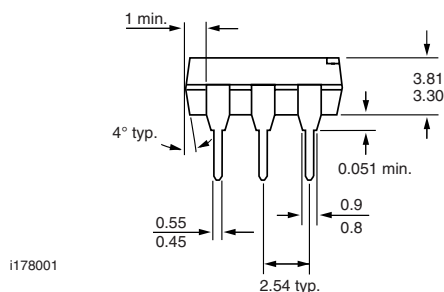
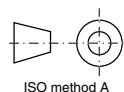
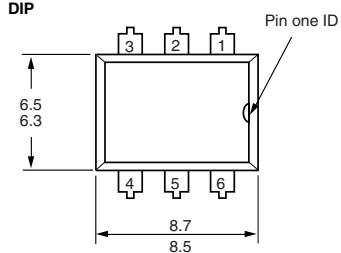
Vishay Semiconductors

1 Form A Solid State Relay

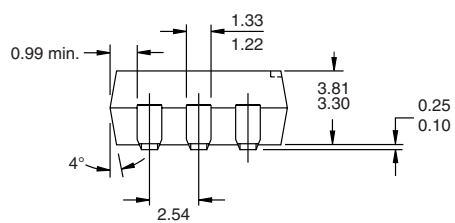
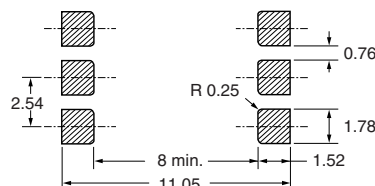
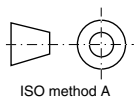
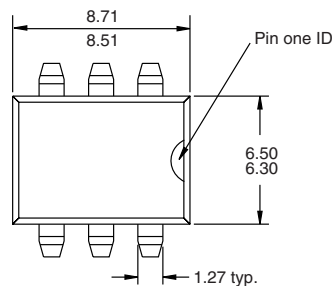


PACKAGE DIMENSIONS in millimeters

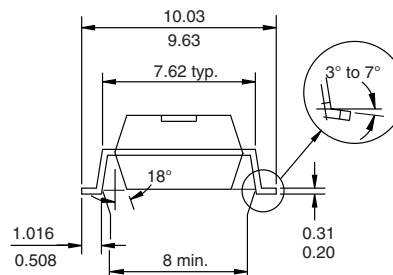
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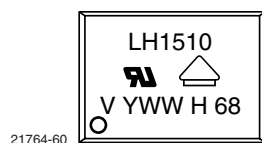
SMD



i178002



PACKAGE MARKING





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